

Semiconductor Business Strategies

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- ■Business Overview
- ■Progress under Medium-Term Management Plan
- ■FY2022 Management Plan
 - Market Outlook
 - Business Policies / Business Plan
 - Priority Measures
 - Capital Investment / Research and Development

Business Overview



Reorganization of industrial, automotive, and information subsegments to form industrial and automotive subsegments in FY2022

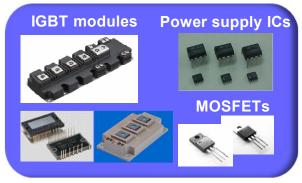
Subsegments

Major Products

Applications, Customer Industries

Industrial

52% of total net sales





Automotive

41% of total net sales



xEV motor control, engine control, transmission control, brake control, steering control, etc.



xEVs, gasoline vehicles

Information

7% of total net sales

Photoconductors



Aluminum substrates, glass substrates



Copiers, printers

HDDs

Withdrawal

Reorganization

into industrial

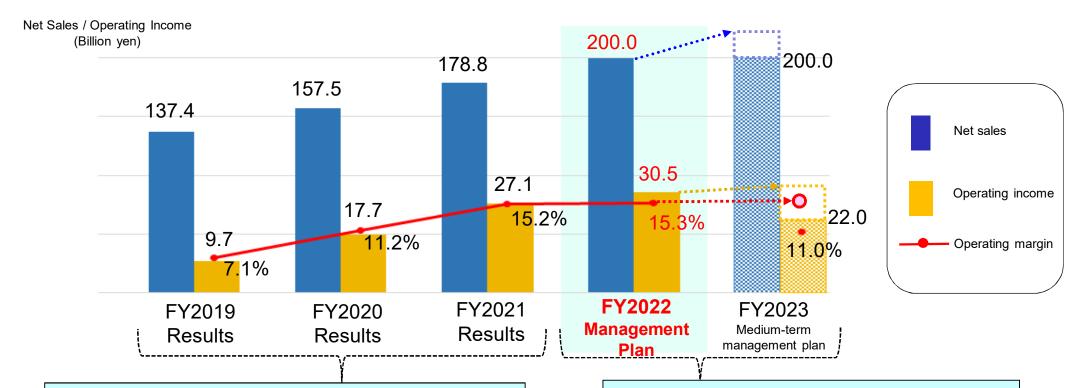
Note: Percentages of total net sales represent FY2021 performance and are calculated before deduction and adjustment for inter-segment sales.

* PCS: Power conditioning systems ©2022 Fuji Electric Co., Ltd. All rights reserved

Progress Under Medium-Term Management Plan



FY2023 targets of medium-term management plan to be accomplished one year in advance in FY2022



FY2019–2021 (Three-Year) Results

- ■14.1% average annual growth in net sales, operating margin surpassing medium-term management plan
- ■Increase in ratio of sales from automotive subsegment (FY2018: 28% → FY2021: 44%)
- ■Increase in ratio of sales accounted for by 7th-generation IGBTs (FY2018: 7% → FY2021: 27%)
- Augmentation of 8-inch wafer production capacity (March 31, 2022: Triple level from March 31, 2019)

Challenges

- Further expansion of sales in growing automotive semiconductor market
- Augmentation of 8-inch Si device production capacity and preparation for emergence of SiC device market

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Market Outlook



Industrial: Continuously favorable demand trends

Automotive: Growth of more than 40% in xEV market and flat growth

in gasoline vehicle market

		Market Outlook (FY2022)	
		YoY Change	Details
Industrial	Factory automation		Continuation of favorable trends in 5G- and semiconductor production equipment-related markets
	Renewable energy	-	Accelerated global decarbonation movement driving shift from fossil fuels to renewable energy
	Consumers, etc.	-	Growth in demand for eco-friendly air-conditioners and home appliances, but dissipation of demand related to people staying at home
Automotive	xEVs		Ongoing trend toward xEVs
	Gasoline vehicles	→	Flat growth

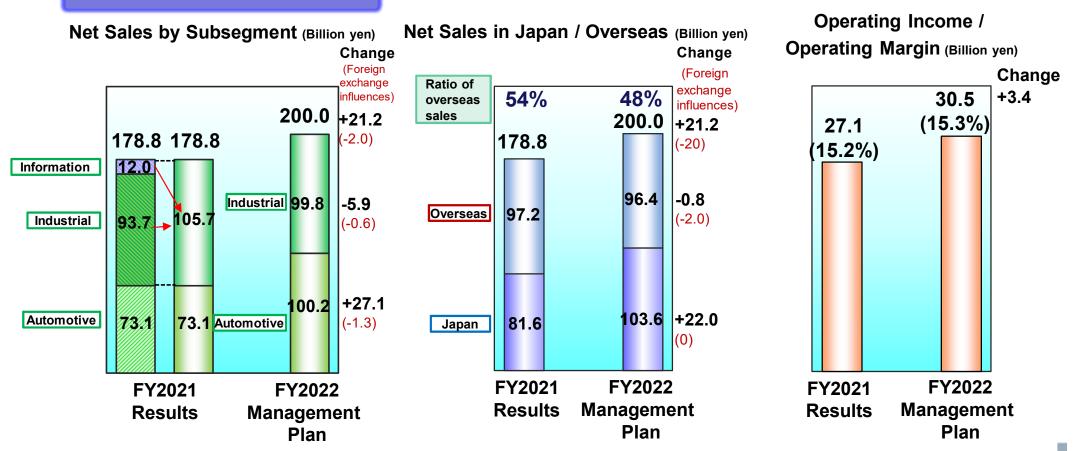
Note: Factory automation comprises inverters, servo, and machine tools etc.; Renewal energy comprises wind power and solar power generation-related products; consumer, etc. comprises products such as household air-conditioners and TVs; and xEVs refers to full hybrid vehicles and electric vehicles (EVs).



Business Policies

Continuation of proactive investment and pursuit of sales growth centered on semiconductors for xEVs

Business Plan



Power Semiconductor Priority Measures

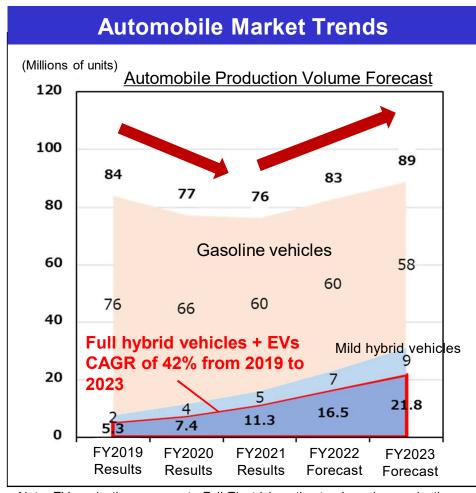


- Automotive field
 - Expansion of sales in growing xEV market
- Industrial field
 - Expansion of sales of 7th-generation IGBTs
- Enhancement of manufacturing
 - Front-end: Bolstering of 8-inch Si device production capacity
 Construction of 6-inch SiC device mass production line
 - Back-end: Augmentation of production capacity and expansion of range of products manufactured
- Development of competitive new products
 - Development of SiC devices and promotion of Fuji Electric's specifications
 - Technological development of 8th-generation IGBTs

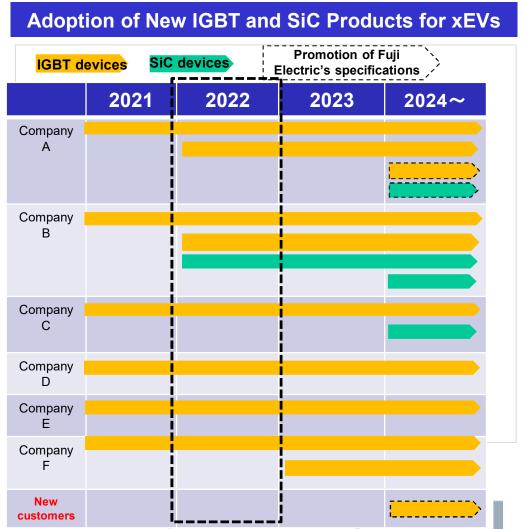
Growing xEV Market and Adoption of New Products



- Flat growth in gasoline vehicle market due to decarbonation, ongoing growth of xEV market
- Increased adoption of Fuji Electric products in new vehicles and launches of new products in FY2022, advancement of campaigns to encourage use of Fuji Electric's specifications underway



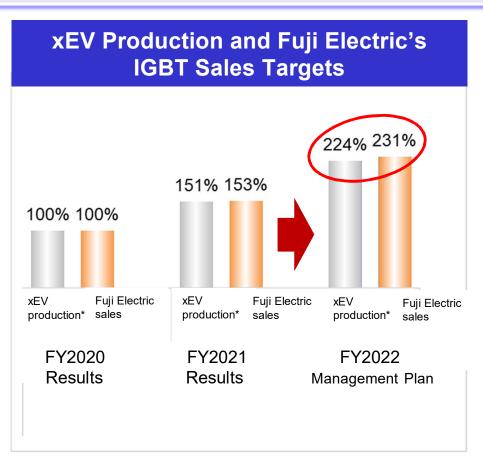
Note: EV production represents Fuji Electric's estimates based on projections by investigation firms and uses the total of full hybrid vehicles and EVs.

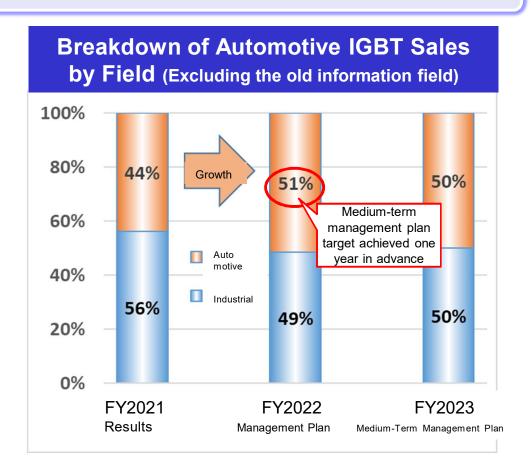


xEV IGBT Sales Targets



- Target pursuing sales growth exceeding xEV market growth rate
- FY2022 expected to raise ratio of sales from automotive semiconductors from 44% to 51%





Note: Figures use the total of full hybrid vehicles and EVs.

SiC Market Trends and Fuji Electric's Initiatives

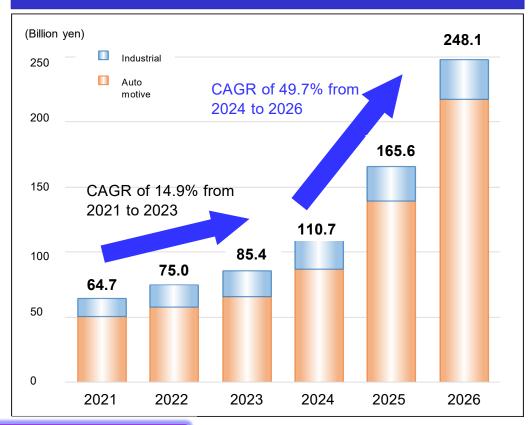


- Massive benefits of using SiC devices in EVs
- SiC device market anticipated to see growth driven by products for EVs beginning after 2024

Benefits of Using SiC devices in EVs

- ◆ Reduced system costs
 Lower battery capacity and battery costs
 Improvement of driving distance versus
 battery capacity
- ◆ Reduction of greenhouse gas emissions⇒ Lower inverter loses
- Reduction of vehicle weight through lower battery capacity
 - ⇒ Increased driving distance
- Higher layout freedom and increased invehicle space made possible by smaller inverters

SiC Module Market Forecast



⇒ Preparation for mass production at Fuji Electric Tsugaru Semiconductor beginning in FY2024

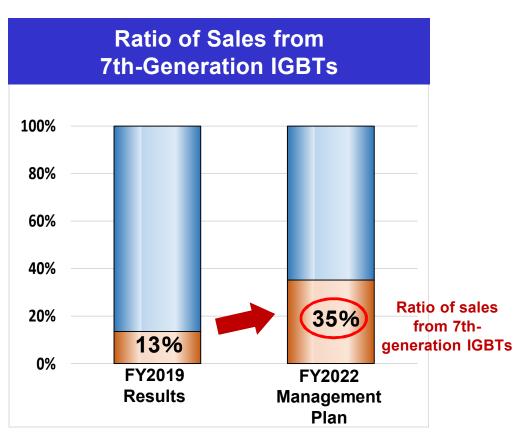
Source: Fuji Electric's estimates based on multiple market data

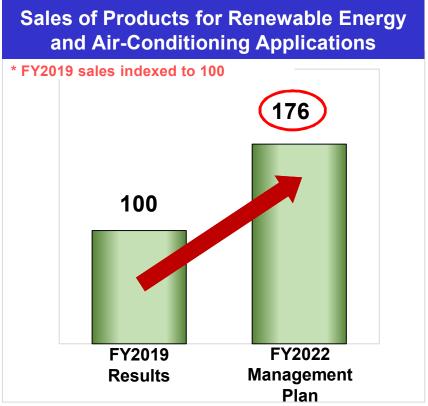
⇒ Development of competitive next-generation products

Industrial Module Sales Targets



- Expansion of sales from 7th-generation IGBTs (ratio of total sales triple that of FY2019)
- Ongoing growth of sales of products for renewable energy and air-conditioning applications (roughly double FY2019)





Enhancement of Manufacturing— Production Bases and Measures (Front-End)



Bases



- Mother factory
- Expansion of 8-inch wafer production capacity
- SiC device production

Japan (Matsumoto)base



- Japan (Tsugaru)
- Expansion of 8-inch wafer production capacity
- SiC device production base (mass production scheduled to begin in FY2024)



- Principal 8-inch wafer factory
- Production of automotive IGBTs and 7th-generation IGBTs





- Production of 6th-generation IGBTs
- Production of 8-inch wafers (mass production scheduled to begin in FY2023)

Malaysia

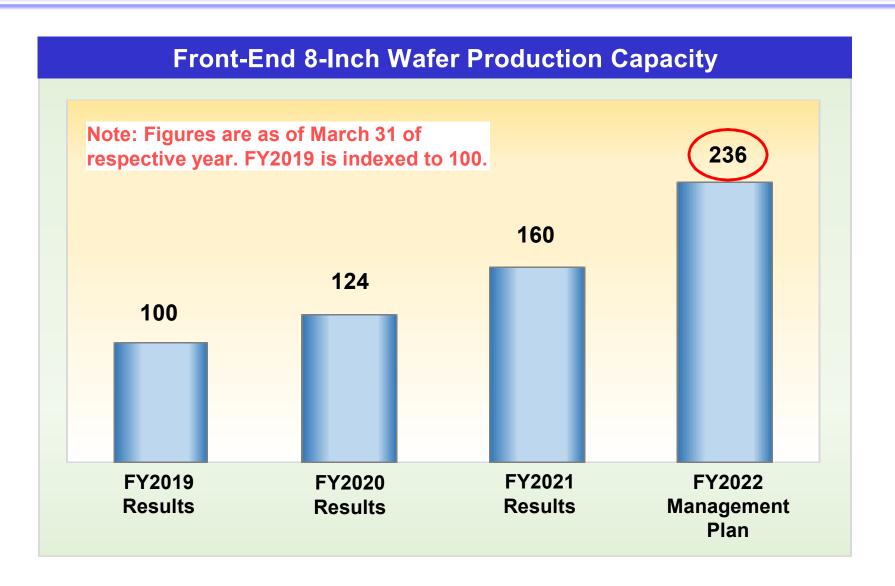
Measures

- Ongoing expansion of 8-inch wafer production capacity (50% year-on-year increase on March 31, 2022)
- Preparation for capacity increase aimed at FY2023 and beyond (including for SiC devices)

8-Inch Wafer Production Capacity Plan



Doubled production capacity to be achieved in comparison to FY2019



Enhancement of Manufacturing— Production Bases and Measures (Back-End)



Bases



 Mother base for assembly products, manufacturing of products for domestic customers, expansion of module production capacity



 Principal discrete device production base, production of automotive pressure sensors and air-conditioner modules

Japan (3 bases)



China (Shenzhen)

 Production base for IGBT modules for Chinese market, expansion of 7th-generaiton IGBT production capacity



Malaysia

 Industrial IGBT module production base, expansion of 7th-generaiton IGBT production capacity

Measures

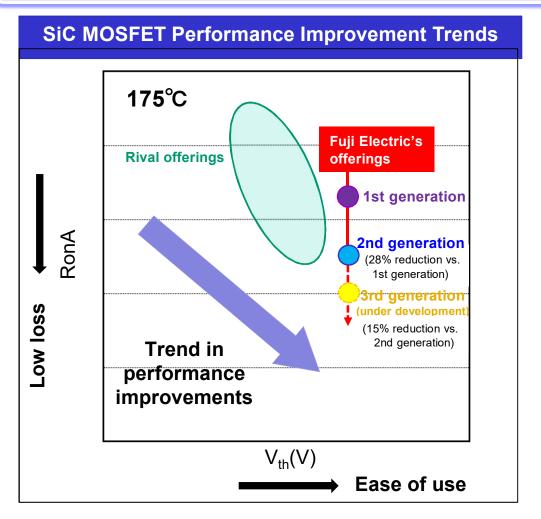
- Expansion of automotive product production capacity
 xEV module production (50% increase from FY2021 level in FY2022)
- Expansion of production capacity and range of models manufactured for industrial modules

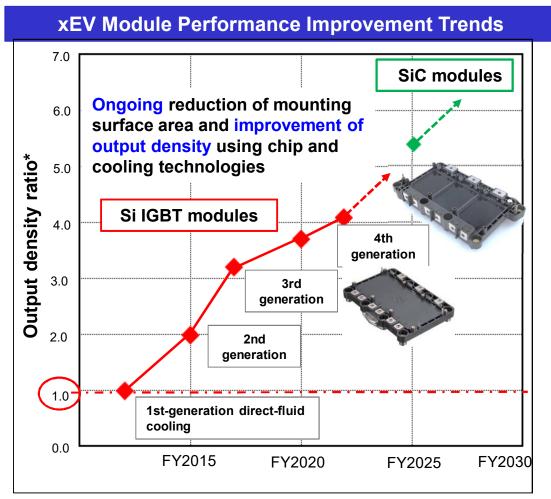
7th-generation IGBT production (30% increase from FY2021 level in FY2022)

Development of Competitive New Products 1—SiC Devices



- Development of SiC MOSFETs with focus on reducing loss while maintaining ease of use
- Application of SiC devices to increase module output density





^{* 1}st-generation direct-fluid cooling indexed to 1

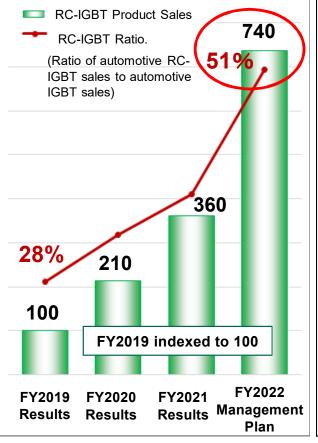
Development of Competitive New Products 2—IGBTs



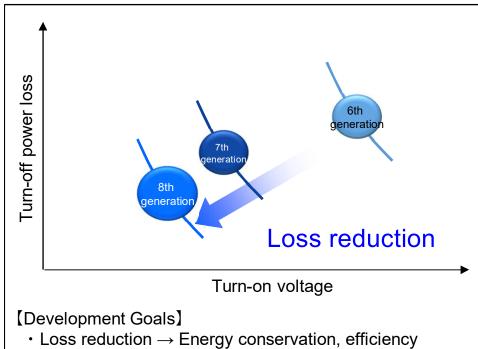
- Expansion of automotive RC-IGBT sales by capitalizing on small size and high reliability
- Development of 8th-generation IGBTs underway targeting mass production after FY2024

Features of RC-IGBT and Automotive Sales Trends and Ratio

Distribution of chip temperature **IGBT FWD** Conventional RC-IGBT **RC-IGBT-equipped** [Benefits of utilizing RC-IGBTs:] · Chip mounting area: 25% reduction ⇒ miniaturization · Chip heat generation: 33% reduction ⇒ increased reliability



Goals of 8th-Generation IGBTs

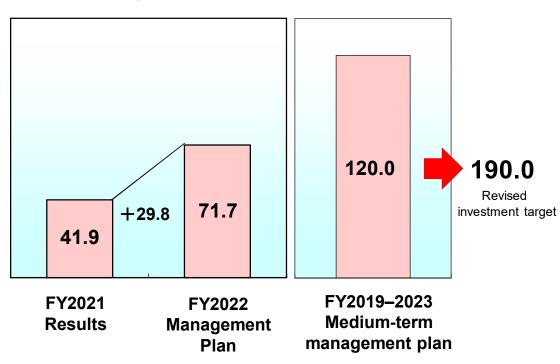


- Loss reduction → Energy conservation, efficiency improvement (15% improvement vs. 7th generation targeted)
- Output increase → Reduction of device size
- Lifespan extension → Long-term reliability improvement

Capital Investment / Research and Development

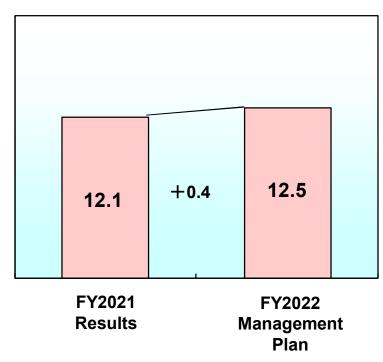


Capital Investment (Billion yen)



- Expansion of front-end (8-inch wafer) production capacity
- Expansion of back-end (automotive module) production capacity

Research and Development (Billion yen)



- Technological development of 8thgeneration IGBTs
- SiC technology development
- Expansion of range of 7th-generation IGBT modules produced

Note: The R&D expenditure figures above represent expenditures that have been allocated to segments based on theme and may therefore differ from figures contained in consolidated financial reports.

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